

# DATA SHEET

## **74HC32; 74HCT32** Quad 2-input OR gate

Product specification  
Supersedes data of 1997 Aug 27

2003 Aug 29

## Quad 2-input OR gate

## 74HC32; 74HCT32

## FEATURES

- Wide supply voltage range from 2.0 to 6.0 V
- Symmetrical output impedance
- High noise immunity
- Low power dissipation
- Balanced propagation delays
- ESD protection:  
HBM EIA/JESD22-A114-A exceeds 2000 V  
MM EIA/JESD22-A115-A exceeds 200 V.

## GENERAL DESCRIPTION

The 74HC/HCT32 is a high-speed Si-gate CMOS device and is pin compatible with low power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard no. 7A.

The 74HC/HCT32 provides the 2-input OR function.

## QUICK REFERENCE DATA

GND = 0 V;  $T_{amb} = 25\text{ }^{\circ}\text{C}$ ;  $t_r = t_f = 6\text{ ns}$ .

SYMBOL	PARAMETER	CONDITIONS	TYPICAL		UNIT
			HC	HCT	
$t_{PHL}/t_{PLH}$	propagation delay nA, nB to nY	$C_L = 15\text{ pF}$ ; $V_{CC} = 5\text{ V}$	6	9	ns
$C_i$	input capacitance		3.5	3.5	pF
$C_{PD}$	power dissipation capacitance per gate	notes 1 and 2	16	28	pF

## Notes

1.  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).  
 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:  
 $f_i$  = input frequency in MHz;  
 $f_o$  = output frequency in MHz;  
 $C_L$  = output load capacitance in pF;  
 $V_{CC}$  = supply voltage in Volts;  
 $N$  = total load switching outputs;  
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.
2. For 74HC32 the condition is  $V_I = \text{GND to } V_{CC}$ .  
 For 74HCT32 the condition is  $V_I = \text{GND to } V_{CC} - 1.5\text{ V}$ .

## FUNCTION TABLE

See note 1.

INPUT		OUTPUT
nA	nB	nY
L	L	L
L	H	H
H	L	H
H	H	H

## Note

1. H = HIGH voltage level;  
L = LOW voltage level.

## Quad 2-input OR gate

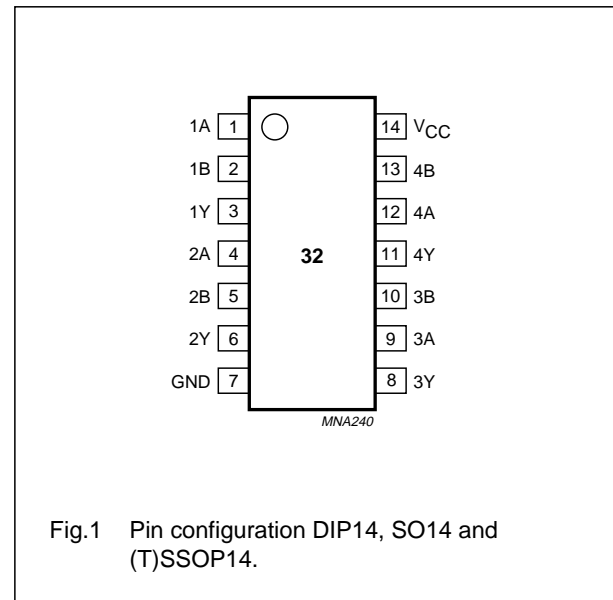
## 74HC32; 74HCT32

## ORDERING INFORMATION

TYPE NUMBER	PACKAGE				
	TEMPERATURE RANGE	PINS	PACKAGE	MATERIAL	CODE
74HC32PW	-40 to +125 °C	14	DIP14	plastic	SOT27-1
74HCT32PW	-40 to +125 °C	14	DIP14	plastic	SOT27-1
74HC32D	-40 to +125 °C	14	SO14	plastic	SOT108-1
74HCT32D	-40 to +125 °C	14	SO14	plastic	SOT108-1
74HC32DB	-40 to +125 °C	14	SSOP14	plastic	SOT337-1
74HCT32DB	-40 to +125 °C	14	SSOP14	plastic	SOT337-1
74HC32N	-40 to +125 °C	14	TSSOP14	plastic	SOT402-1
74HCT32N	-40 to +125 °C	14	TSSOP14	plastic	SOT402-1
74HC32BQ	-40 to +125 °C	14	DHVQFN14	plastic	SOT762-1
74HCT32BQ	-40 to +125 °C	14	DHVQFN14	plastic	SOT762-1

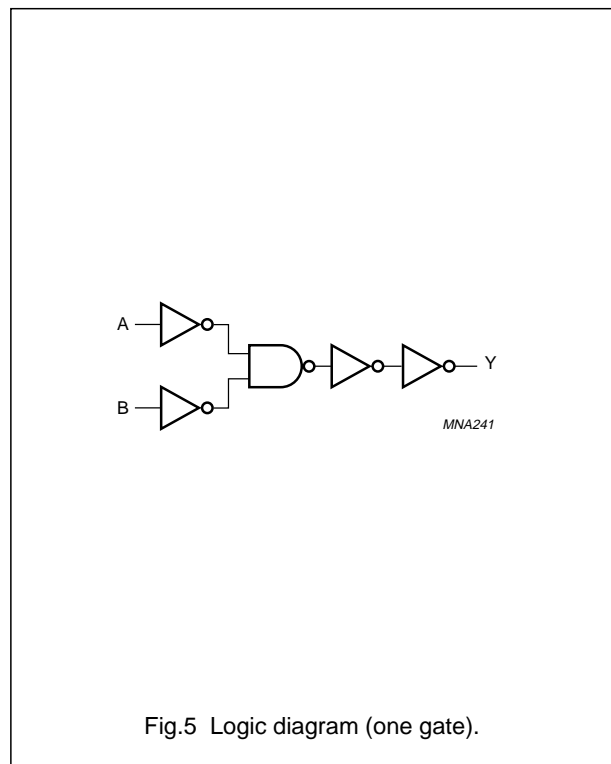
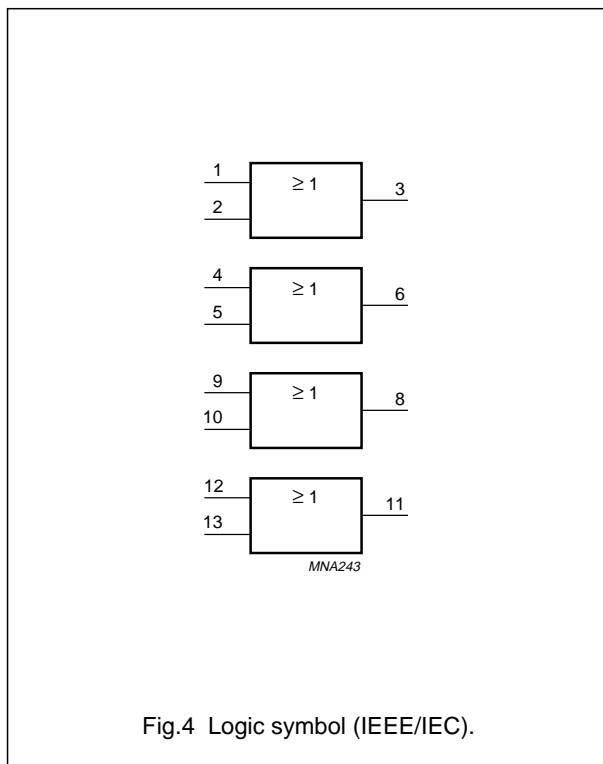
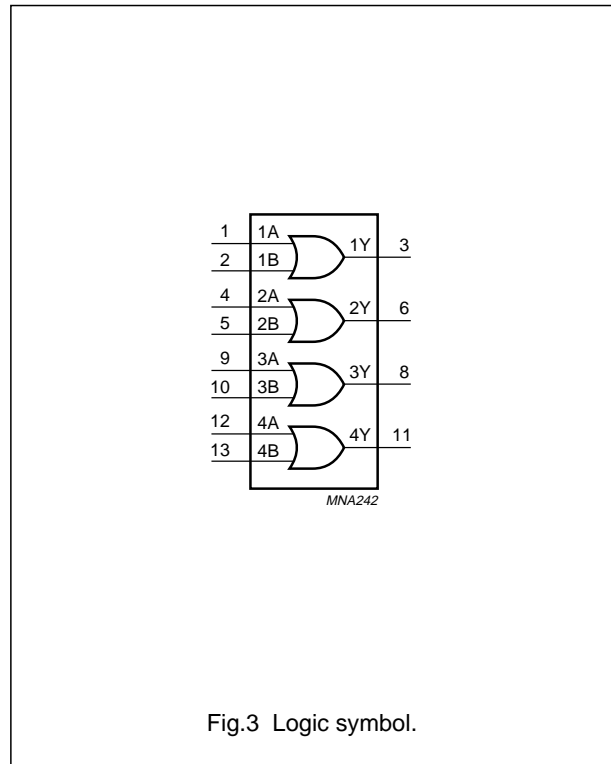
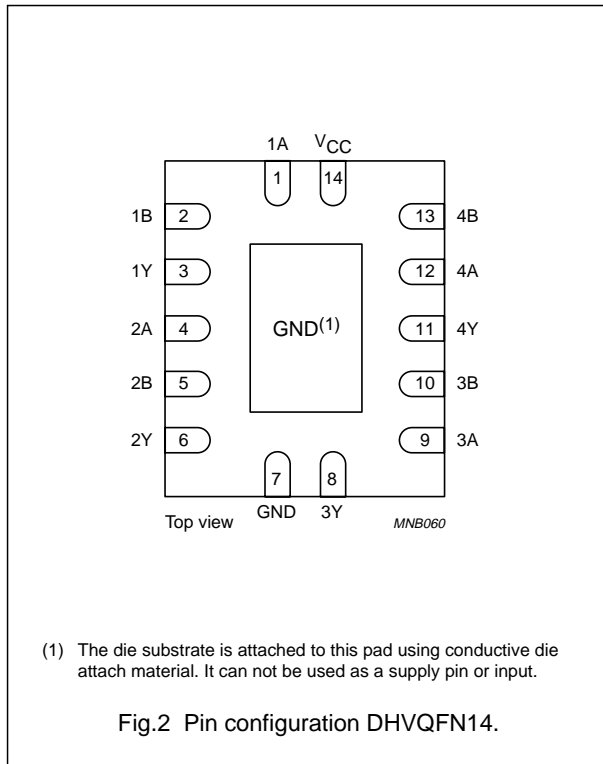
## PINNING

PIN	SYMBOL	DESCRIPTION
1	1A	data input
2	1B	data input
3	1Y	data output
4	2A	data input
5	2B	data input
6	2Y	data output
7	GND	ground (0 V)
8	3Y	data output
9	3A	data input
10	3B	data input
11	4Y	data output
12	4A	data input
13	4B	data input
14	V <sub>CC</sub>	supply voltage



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## RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	74HC32			74HCT32			UNIT
			MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
$V_{CC}$	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
$V_I$	input voltage		0	–	$V_{CC}$	0	–	$V_{CC}$	V
$V_O$	output voltage		0	–	$V_{CC}$	0	–	$V_{CC}$	V
$T_{amb}$	operating ambient temperature		–40	+25	+125	–40	+25	+125	°C
$t_r, t_f$	input rise and fall times	$V_{CC} = 2.0\text{ V}$	–	–	1000	–	–	–	ns
		$V_{CC} = 4.5\text{ V}$	–	6.0	500	–	6.0	500	ns
		$V_{CC} = 6.0\text{ V}$	–	–	400	–	–	–	ns

## LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134); voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CC}$	supply voltage		–0.5	+7.0	V
$I_{IK}$	input diode current	$V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$ ; note 1	–	±20	mA
$I_{OK}$	output diode current	$V_O < -0.5\text{ V}$ or $V_O > V_{CC} + 0.5\text{ V}$ ; note 1	–	±20	mA
$I_O$	output source or sink current	$-0.5\text{ V} < V_O < V_{CC} + 0.5\text{ V}$ ; note 1	–	±25	mA
$I_{CC}; I_{GND}$	$V_{CC}$ or GND current	note 1	–	±50	mA
$T_{stg}$	storage temperature		–65	+150	°C
$P_D$	power dissipation	$T_{amb} = -40\text{ to }+125\text{ °C}$ ; note 2	–	300	mW

## Notes

- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
- For DIP14 packages: above 70 °C the value of  $P_D$  derates linearly with 12 mW/K.  
For SO14 packages: above 70 °C the value of  $P_D$  derates linearly with 8 mW/K.  
For SSOP14 and TSSOP14 packages: above 60 °C the value of  $P_D$  derates linearly with 5.5 mW/K.  
For DHVQFN14 packages: above 60 °C the value of  $P_D$  derates linearly with 4.5 mW/K.

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## DC CHARACTERISTICS

## Family 74HC

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		OTHER	V <sub>CC</sub> (V)				
<b>T<sub>amb</sub> = 25 °C; note 1</b>							
V <sub>IH</sub>	HIGH-level input voltage		2.0	1.5	1.2	–	V
			4.5	3.15	2.4	–	V
			6.0	4.2	3.2	–	V
V <sub>IL</sub>	LOW-level input voltage		2.0	–	0.8	0.5	V
			4.5	–	2.1	1.35	V
			6.0	–	2.8	1.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = –20 µA	2.0	1.9	2.0	–	V
		I <sub>O</sub> = –20 µA	4.5	4.4	4.5	–	V
		I <sub>O</sub> = –20 µA	6.0	5.9	6.0	–	V
		I <sub>O</sub> = –4.0 mA	4.5	3.98	4.32	–	V
		I <sub>O</sub> = –5.2 mA	6.0	5.48	5.81	–	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = 20 µA	2.0	–	0	0.1	V
		I <sub>O</sub> = 20 µA	4.5	–	0	0.1	V
		I <sub>O</sub> = 20 µA	6.0	–	0	0.1	V
		I <sub>O</sub> = 4.0 mA	4.5	–	0.15	0.26	V
		I <sub>O</sub> = 5.2 mA	6.0	–	0.16	0.26	V
I <sub>LI</sub>	input leakage current	V <sub>I</sub> = V <sub>CC</sub> or GND	6.0	–	–	±0.1	µA
I <sub>CC</sub>	quiescent supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0	6.0	–	–	2.0	µA

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SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		OTHER	$V_{CC}$ (V)				
$T_{amb} = -40$ to $+85$ °C							
$V_{IH}$	HIGH-level input voltage		2.0	1.5	–	–	V
			4.5	3.15	–	–	V
			6.0	4.2	–	–	V
$V_{IL}$	LOW-level input voltage		2.0	–	–	0.5	V
			4.5	–	–	1.35	V
			6.0	–	–	1.8	V
$V_{OH}$	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$ $I_O = -20$ $\mu$ A	2.0	1.9	–	–	V
		$I_O = -20$ $\mu$ A	4.5	4.4	–	–	V
		$I_O = -20$ $\mu$ A	6.0	5.9	–	–	V
		$I_O = -4.0$ mA	4.5	3.84	–	–	V
		$I_O = -5.2$ mA	6.0	5.34	–	–	V
$V_{OL}$	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$ $I_O = 20$ $\mu$ A	2.0	–	–	0.1	V
		$I_O = 20$ $\mu$ A	4.5	–	–	0.1	V
		$I_O = 20$ $\mu$ A	6.0	–	–	0.1	V
		$I_O = 4.0$ mA	4.5	–	–	0.33	V
		$I_O = 5.2$ mA	6.0	–	–	0.33	V
$I_{LI}$	input leakage current	$V_I = V_{CC}$ or GND	6.0	–	–	$\pm 1.0$	$\mu$ A
$I_{CC}$	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$	6.0	–	–	20	$\mu$ A

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SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		OTHER	$V_{CC}$ (V)				
<b><math>T_{amb} = -40</math> to <math>+125</math> °C</b>							
$V_{IH}$	HIGH-level input voltage		2.0	1.5	–	–	V
			4.5	3.15	–	–	V
			6.0	4.2	–	–	V
$V_{IL}$	LOW-level input voltage		2.0	–	–	0.5	V
			4.5	–	–	1.35	V
			6.0	–	–	1.8	V
$V_{OH}$	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$ $I_O = -20$ $\mu$ A	2.0	1.9	–	–	V
		$I_O = -20$ $\mu$ A	4.5	4.4	–	–	V
		$I_O = -20$ $\mu$ A	6.0	5.9	–	–	V
		$I_O = -4.0$ mA	4.5	3.7	–	–	V
		$I_O = -5.2$ mA	6.0	5.2	–	–	V
$V_{OL}$	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$ $I_O = 20$ $\mu$ A	2.0	–	–	0.1	V
		$I_O = 20$ $\mu$ A	4.5	–	–	0.1	V
		$I_O = 20$ $\mu$ A	6.0	–	–	0.1	V
		$I_O = 4.0$ mA	4.5	–	–	0.4	V
		$I_O = 5.2$ mA	6.0	–	–	0.4	V
$I_{LI}$	input leakage current	$V_I = V_{CC}$ or GND	6.0	–	–	$\pm 0.1$	$\mu$ A
$I_{CC}$	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$	6.0	–	–	40	$\mu$ A

**Note**

1. All typical values are measured at  $T_{amb} = 25$  °C.



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## Family 74HCT

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		OTHER	V <sub>CC</sub> (V)				
<b>T<sub>amb</sub> = 25 °C; note 1</b>							
V <sub>IH</sub>	HIGH-level input voltage		4.5 to 5.5	2.0	1.6	–	V
V <sub>IL</sub>	LOW-level input voltage		4.5 to 5.5	–	1.2	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	4.5	4.4	4.5	–	V
		I <sub>O</sub> = –20 µA I <sub>O</sub> = –4 mA	4.5	3.98	4.32	–	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	4.5	–	0	0.1	V
		I <sub>O</sub> = 20 µA I <sub>O</sub> = 4 mA	4.5	–	0.15	0.25	V
I <sub>LI</sub>	input leakage current	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5	–	–	±0.1	µA
I <sub>CC</sub>	quiescent supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0	5.5	–	–	2.0	µA
ΔI <sub>CC</sub>	additional quiescent supply current per input	V <sub>I</sub> = V <sub>CC</sub> – 2.1 V; I <sub>O</sub> = 0	4.5 to 5.5	–	–	430	µA
<b>T<sub>amb</sub> = –40 to +85 °C</b>							
V <sub>IH</sub>	HIGH-level input voltage		4.5 to 5.5	2.0	–	–	V
V <sub>IL</sub>	LOW-level input voltage		4.5 to 5.5	–	–	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	4.5	4.4	–	–	V
		I <sub>O</sub> = –20 µA I <sub>O</sub> = –4 mA	4.5	3.84	–	–	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	4.5	–	–	0.1	V
		I <sub>O</sub> = 20 µA I <sub>O</sub> = 4 mA	4.5	–	–	0.33	V
I <sub>LI</sub>	input leakage current	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5	–	–	±1.0	µA
I <sub>CC</sub>	quiescent supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0	5.5	–	–	20	µA
ΔI <sub>CC</sub>	additional quiescent supply current per input	V <sub>I</sub> = V <sub>CC</sub> – 2.1 V; I <sub>O</sub> = 0	4.5 to 5.5	–	–	540	µA

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SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		OTHER	V <sub>CC</sub> (V)				
<b>T<sub>amb</sub> = -40 to +125 °C</b>							
V <sub>IH</sub>	HIGH-level input voltage		4.5 to 5.5	2.0	–	–	V
V <sub>IL</sub>	LOW-level input voltage		4.5 to 5.5	–	–	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = -20 µA	4.5	4.4	–	–	V
		I <sub>O</sub> = -4 mA	4.5	3.7	–	–	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>O</sub> = 20 µA	4.5	–	–	0.1	V
		I <sub>O</sub> = 4 mA	4.5	–	–	0.4	V
I <sub>LI</sub>	input leakage current	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5	–	–	±1.0	µA
I <sub>CC</sub>	quiescent supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0	5.5	–	–	40	µA
ΔI <sub>CC</sub>	additional quiescent supply current per input	V <sub>I</sub> = V <sub>CC</sub> - 2.1 V; I <sub>O</sub> = 0	4.5 to 5.5	–	–	590	µA

**Note**

1. All typical values are measured at T<sub>amb</sub> = 25 °C.

## Quad 2-input OR gate

## 74HC32; 74HCT32

## AC CHARACTERISTICS

## Family 74HC

GND = 0 V;  $t_r = t_f = 6$  ns;  $C_L = 50$  pF.

SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		WAVEFORMS	V <sub>CC</sub> (V)				
<b>T<sub>amb</sub> = 25 °C; note 1</b>							
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay nA, nB to nY	see Figs 6 and 7	2.0	–	22	90	ns
			4.5	–	8	18	ns
			6.0	–	6	15	ns
t <sub>THL</sub> /t <sub>TLH</sub>	output transition time	see Figs 6 and 7	2.0	–	19	75	ns
			4.5	–	7	15	ns
			6.0	–	6	13	ns
<b>T<sub>amb</sub> = –40 to +85 °C</b>							
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay nA, nB to nY	see Figs 6 and 7	2.0	–	–	115	ns
			4.5	–	–	23	ns
			6.0	–	–	20	ns
t <sub>THL</sub> /t <sub>TLH</sub>	output transition time	see Figs 6 and 7	2.0	–	–	95	ns
			4.5	–	–	19	ns
			6.0	–	–	16	ns
<b>T<sub>amb</sub> = –40 to +125 °C</b>							
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay nA, nB to nY	see Figs 6 and 7	2.0	–	–	135	ns
			4.5	–	–	27	ns
			6.0	–	–	23	ns
t <sub>THL</sub> /t <sub>TLH</sub>	output transition time	see Figs 6 and 7	2.0	–	–	110	ns
			4.5	–	–	22	ns
			6.0	–	–	19	ns

## Note

1. All typical values are measured at T<sub>amb</sub> = 25 °C.

## Quad 2-input OR gate

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**Family 74HCT**GND = 0 V;  $t_r = t_f = 6$  ns;  $C_L = 50$  pF.

SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		WAVEFORMS	V <sub>CC</sub> (V)				
<b>T<sub>amb</sub> = 25 °C; note 1</b>							
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay nA, nB to nY	see Figs 6 and 7	4.5	–	11	24	ns
t <sub>THL</sub> /t <sub>TLH</sub>	output transition time	see Figs 6 and 7	4.5	–	7	15	ns
<b>T<sub>amb</sub> = –40 to +85 °C</b>							
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay nA, nB to nY	see Figs 6 and 7	4.5	–	–	30	ns
t <sub>THL</sub> /t <sub>TLH</sub>	output transition time	see Figs 6 and 7	4.5	–	–	19	ns
<b>T<sub>amb</sub> = –40 to +125 °C</b>							
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay nA, nB to nY	see Figs 6 and 7	4.5	–	–	36	ns
t <sub>THL</sub> /t <sub>TLH</sub>	output transition time	see Figs 6 and 7	4.5	–	–	22	ns

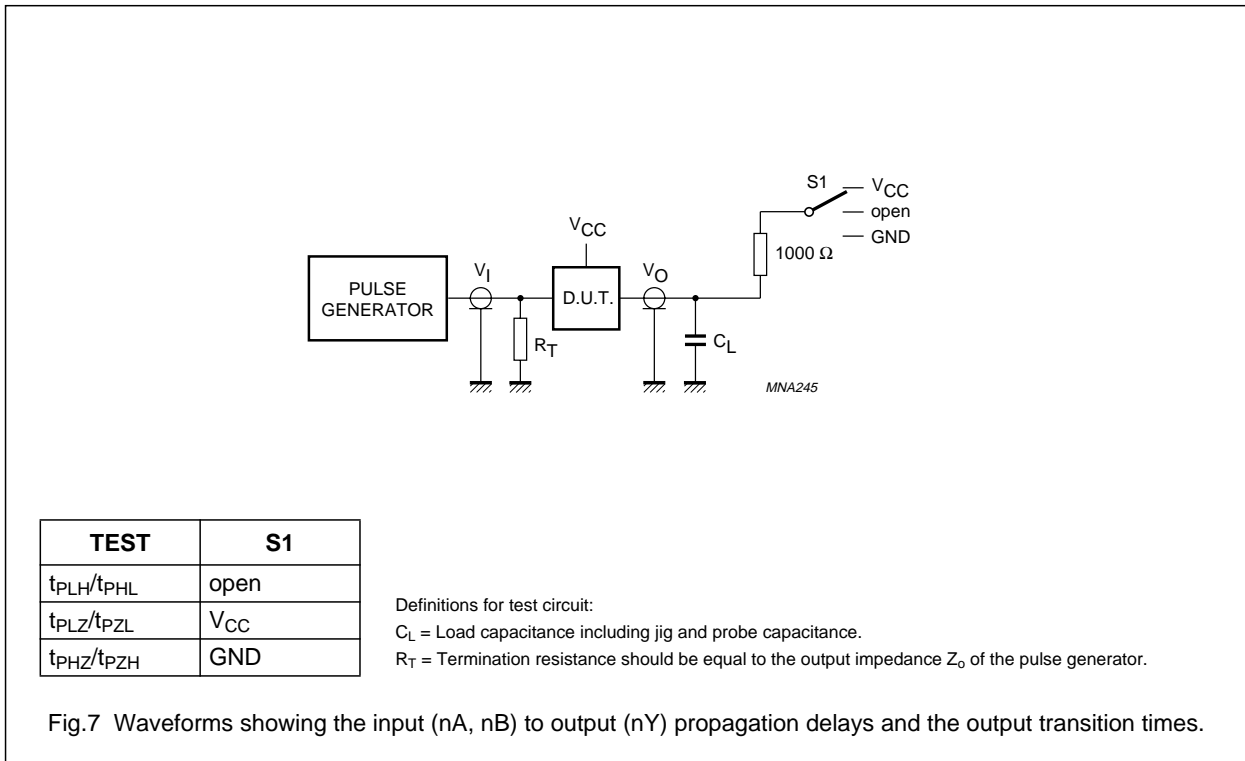
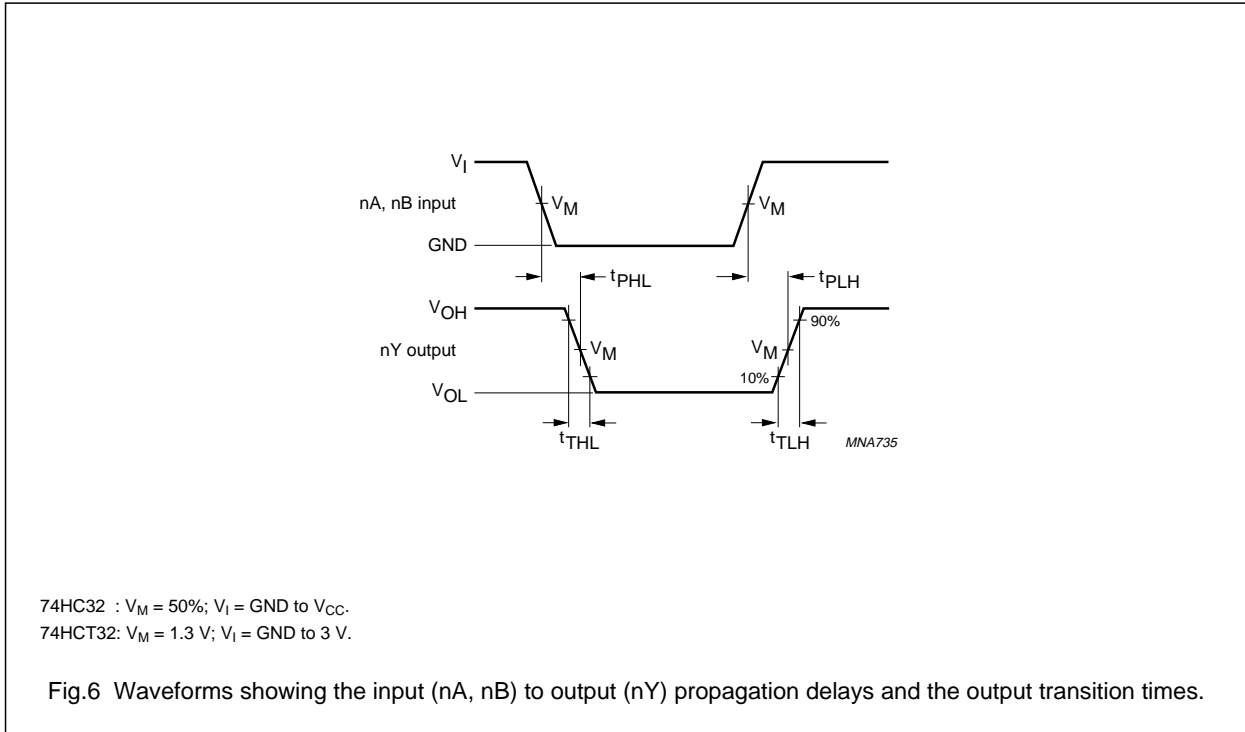
**Note**

1. All typical values are measured at T<sub>amb</sub> = 25 °C.

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AC WAVEFORMS



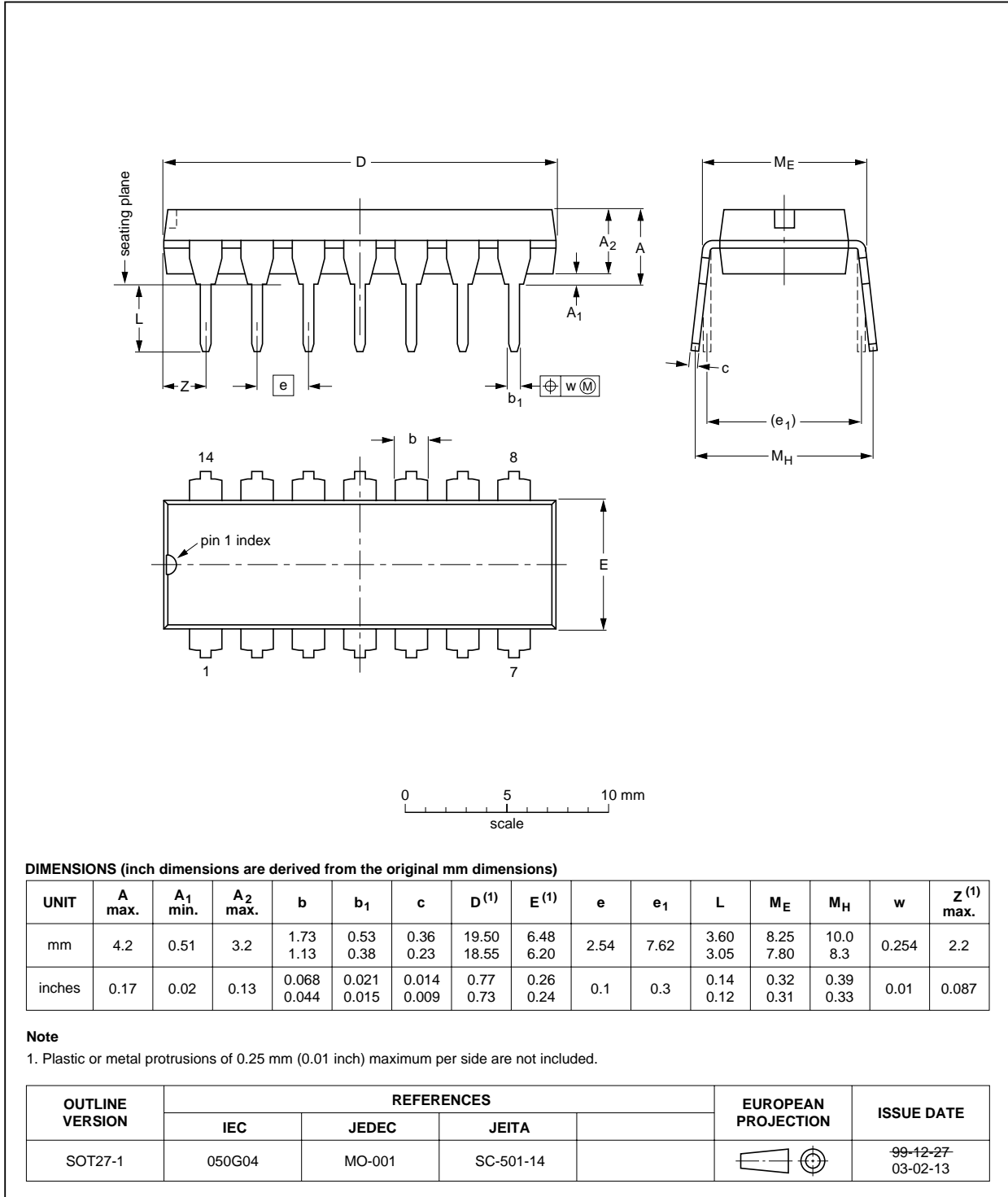
Quad 2-input OR gate

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PACKAGE OUTLINES

DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1

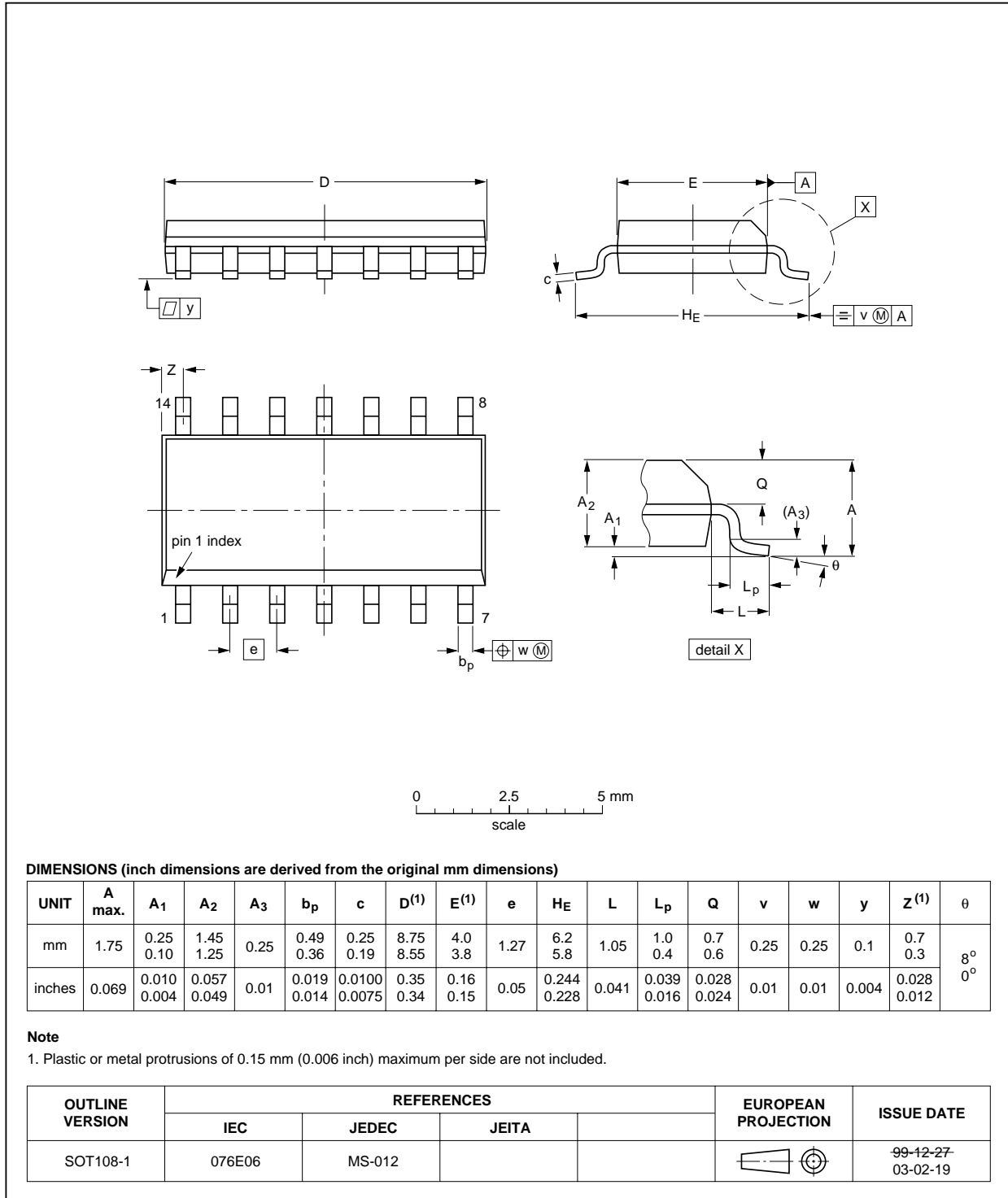


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SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

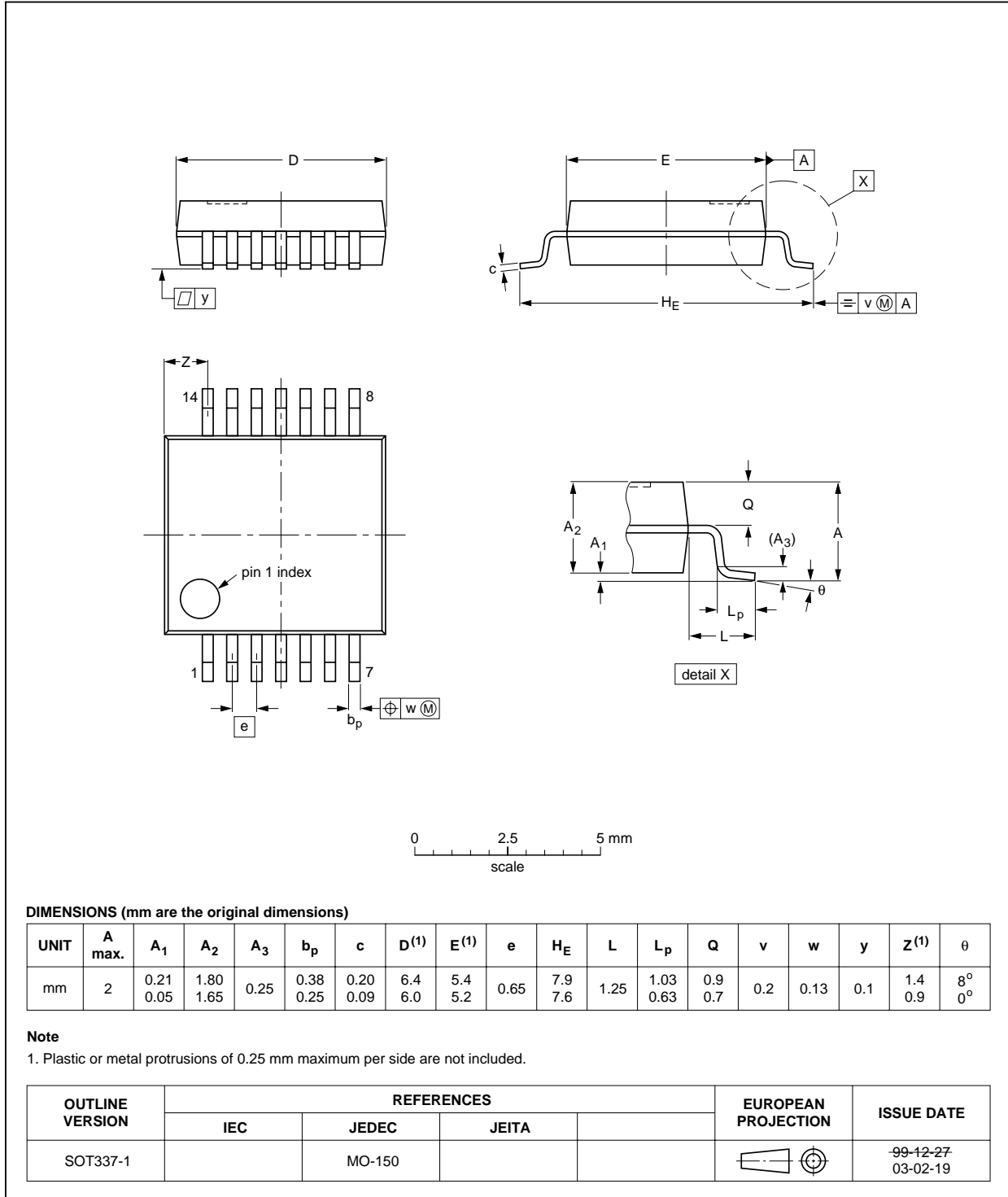


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SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



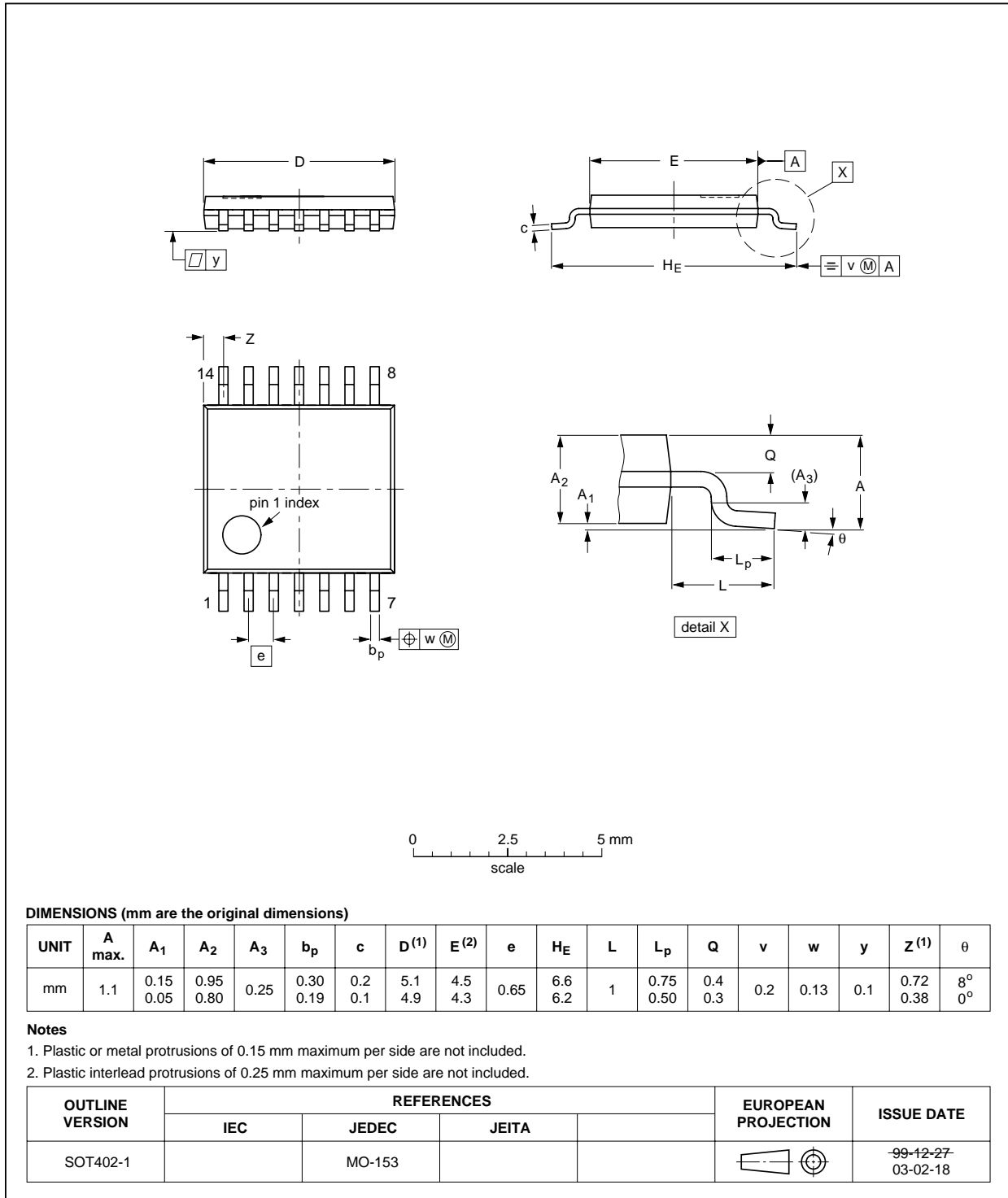


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TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

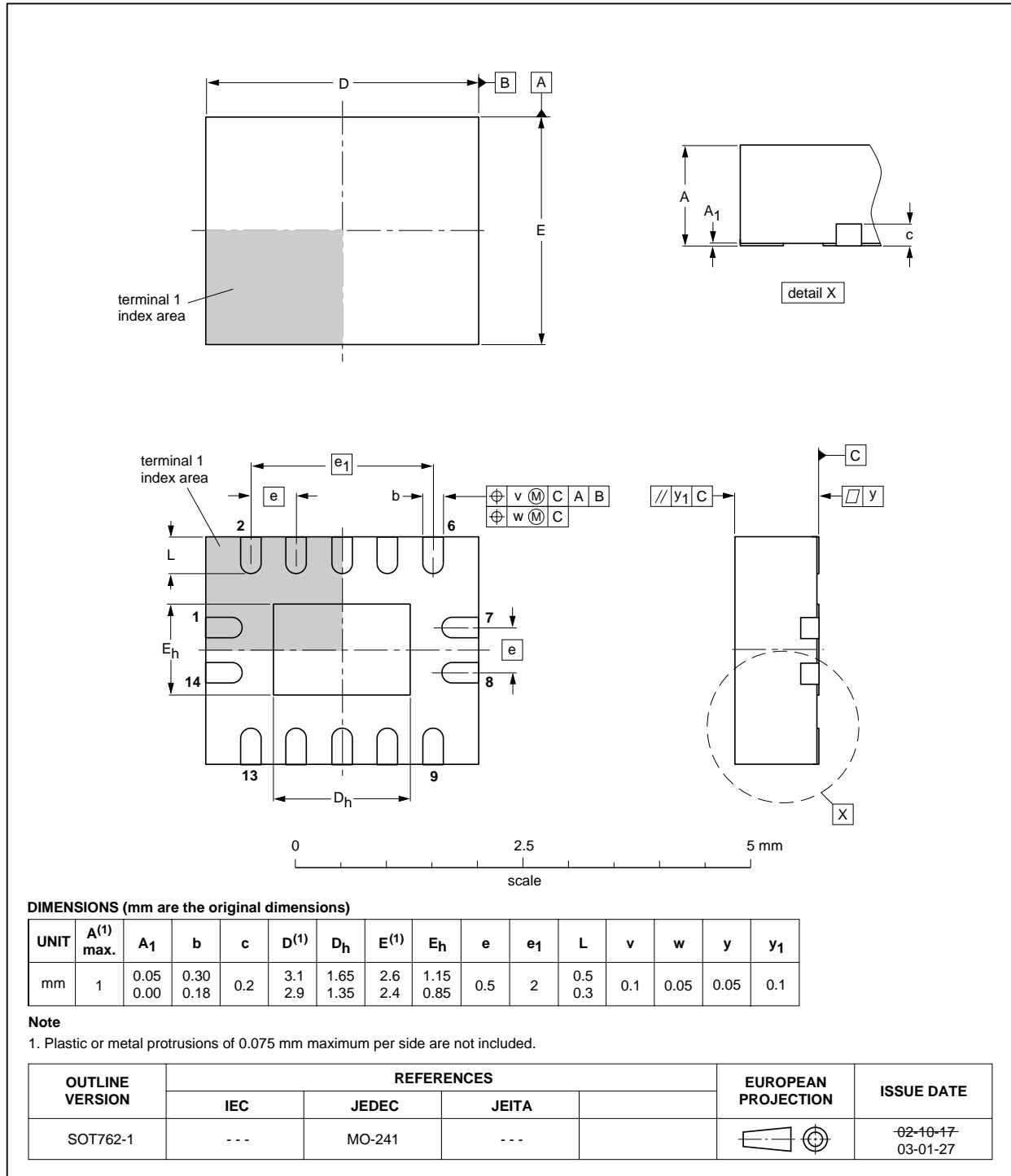


Quad 2-input OR gate

74HC32; 74HCT32

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1



## Quad 2-input OR gate

## 74HC32; 74HCT32

## DATA SHEET STATUS

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)(3)</sup>	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

## Notes

1. Please consult the most recently issued data sheet before initiating or completing a design.
2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.
3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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**Limiting values definition** — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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